

**PATENT ASSIGNMENT**

Electronic Version v1.1  
 Stylesheet Version v1.1

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT

**CONVEYING PARTY DATA**

Name	Execution Date
Dong-Kil Yim	08/22/2006
John M. White	08/31/2006
Soo Young Choi	08/29/2006
Han Byoul Kim	09/27/2006
Jin Man Ha	08/24/2006
Beom Soo Park	08/29/2006

**RECEIVING PARTY DATA**

<b>Name:</b>	Applied Materials, Inc.
<b>Street Address:</b>	3050 Bowers Avenue
<b>City:</b>	Santa Clara
<b>State/Country:</b>	CALIFORNIA
<b>Postal Code:</b>	95054

**PROPERTY NUMBERS Total: 1**

Property Type	Number
<b>Application Number:</b>	13315366

**CORRESPONDENCE DATA**

**Fax Number:** (732)530-9808  
**Phone:** 732-530-9404  
**Email:** adevesty@pattersonsheridan.com,  
 psdocketing@pattersonsheridan.com

*Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.*

**Correspondent Name:** Patterson & Sheridan, LLP  
**Address Line 1:** 595 Shrewsbury Avenue  
**Address Line 2:** Suite 100  
**Address Line 4:** Shrewsbury, NEW JERSEY 07702

OP \$40.00 13315366

ATTORNEY DOCKET NUMBER:	APPM/11061 C1
NAME OF SUBMITTER:	Keith Taboada
Total Attachments: 8 source=APPM_11061C1_EASSIGN_12_11#page1.tif source=APPM_11061C1_EASSIGN_12_11#page2.tif source=APPM_11061C1_EASSIGN_12_11#page3.tif source=APPM_11061C1_EASSIGN_12_11#page4.tif source=APPM_11061C1_EASSIGN_12_11#page5.tif source=APPM_11061C1_EASSIGN_12_11#page6.tif source=APPM_11061C1_EASSIGN_12_11#page7.tif source=APPM_11061C1_EASSIGN_12_11#page8.tif	

**ASSIGNMENT FOR APPLICATION FOR PATENT**

WHEREAS:

Names and Addresses of Inventors:

1)	<b>DONG-KIL YIM</b> #310-1101 Halla Apt., Cheongsol-Maeul, Keumgok-Dong Pundang-Ku, Sungnam-City, Kyunggi-Do. 463-725, Korea	2)	<b>JOHN M. WHITE</b> 2811 Colony View Place Hayward, CA 94541
3)	<b>SOO YOUNG CHOI</b> 40907 Rioja Court Fremont, CA 94539	4)	<b>HAN BYOUL KIM</b> 1183, Gyoung-Eun Villa #406 Sung Jung Dong, Chon An City, Chung Cheong Nam Do, Korea
5)	<b>JIN MAN HA</b> 101 ho 126-9, Sinseong-dong Yuseong-gu, Daejeon, 305-804 South Korea	6)	<b>BEOM SOO PARK</b> 6870 Aintree Drive San Jose, CA 95119

(hereinafter referred to as Assignors), have invented a certain invention entitled:

**POWER LOADING SUBSTRATES TO REDUCE PARTICLE CONTAMINATION**

enclosed herewith or for which application for Letters Patent in the United States was filed on 06/29/2006, under Serial No. 11/478,279, executed on even date herewith; and

WHEREAS, Applied Materials, Inc., a corporation of the State of Delaware, having a place of business at 3050 Bowers Avenue, Santa Clara, California 95054 (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said application (hereinafter referred to as Application), and the invention disclosed therein (hereinafter referred to as Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignors, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignors to have been received in full from said Assignee:


1. Said Assignors hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a conventional, division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.

2. Said Assignors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignors shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting conventional, substitute, divisional, continuing or additional applications covering said Invention; (d) for filing and prosecuting applications for reissuance of any of said Patents; (e) for interference or other priority proceedings involving said Invention; and (f) for legal proceedings involving said Invention and any application therefor and any Patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Assignors in providing such cooperation shall be paid for by said Assignee.

3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignors, their respective heirs, legal representatives and assigns.

4. Said Assignors hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the dates indicated below.

- 1) Aug 22, 2006 (DATE)   
DONG-KIL YIM
- 2) \_\_\_\_\_ (DATE) \_\_\_\_\_  
JOHN M. WHITE
- 3) \_\_\_\_\_ (DATE) \_\_\_\_\_  
SOO YOUNG CHOI
- 4) \_\_\_\_\_ (DATE) \_\_\_\_\_  
HAN BYOUL KIM
- 5) \_\_\_\_\_ (DATE) \_\_\_\_\_  
JIN MAN HA
- 6) \_\_\_\_\_ (DATE) \_\_\_\_\_  
BEOM SOO PARK

**ASSIGNMENT FOR APPLICATION FOR PATENT**

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Names and Addresses of Inventors:

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<p>3) <b>SOO YOUNG CHOI</b> 40907 Rioja Court Fremont, CA 94539</p>	<p>4) <b>HAN BYOUL KIM</b> 1183, Gyoung-Eun Villa #406 Sung Jung Dong, Chon An City, Chung Cheong Nam Do, Korea</p>
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NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignors to have been received in full from said Assignee:



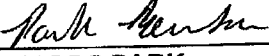
1. Said Assignors hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a conventional, division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.

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IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the dates indicated below.

1)	_____ (DATE)	_____	DONG-KIL YIM
2)	<u>8/31/06</u> (DATE)		JOHN M. WHITE
3)	<u>8-29-06</u> (DATE)		SOO YOUNG CHOI
4)	_____ (DATE)	_____	HAN BYOUL KIM
5)	_____ (DATE)	_____	JIN MAN HA
6)	<u>8-29-2006</u> (DATE)		BEOM SOO PARK

**ASSIGNMENT FOR APPLICATION FOR PATENT**

WHEREAS:

Names and Addresses of Inventors:

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3)	_____ (DATE)	_____	SOO YOUNG CHOI
4)	2006. 9. 29 (DATE)	_____	HAN-BYOUNG KIM
5)	_____ (DATE)	_____	JIN MAN HA
6)	_____ (DATE)	_____	BEOM SOO PARK



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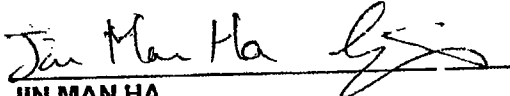
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3)	_____ (DATE)	_____
		SOO YOUNG CHOI
4)	_____ (DATE)	_____
		HAN BYOUL KIM
5)	Aug. 24, 01 (DATE)	
		JIN MAN HA
6)	_____ (DATE)	_____
		BEOM SOO PARK